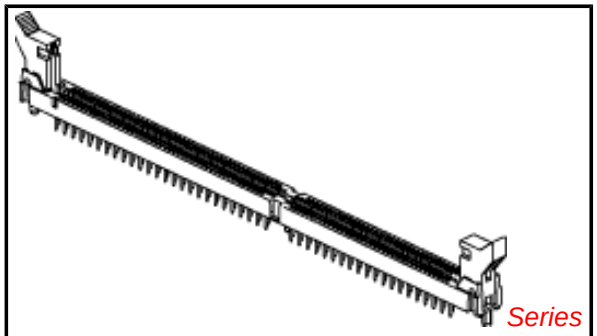
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PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: 0712433002
Status: Active
Description: 1.27mm (.050") Pitch DDR DIMM Socket, Single Key, Vertical, 184 Circuits, Offset



Series image - Reference only

Documents:

3D Model
Drawing (PDF)
Product Specification PS-71243-9999 (PDF)
RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	Memory Module Sockets
Series	71243
Component Type	Memory Module
JEDEC Outline	MO-206
Product Name	DDR DIMM, DIMM

Physical

Circuits (Loaded)	184
Circuits (maximum)	184
Color - Resin	Black, Natural
Durability (mating cycles max)	25
Entry Angle	Vertical
Flammability	94V-0
Function Key	None
Keying to Mating Part	Yes
Material - Metal	Phosphor Bronze, Stainless Steel
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
PC Tail Length (in)	0.127 In
PC Tail Length (mm)	3.23 mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.57 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.050 In
Pitch - Mating Interface (mm)	1.27 mm
Pitch - Term. Interface (in)	0.050 In
Pitch - Term. Interface (mm)	1.27 mm
Plating min: Mating (µin)	2
Plating min: Mating (µm)	0.05
Plating min: Termination (µin)	150
Plating min: Termination (µm)	3.81
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	1A
Voltage - Maximum	100V AC (RMS)/DC
Voltage Key	Left

Solder Process Data

Duration at Max. Process Temperature (seconds)	5

EU RoHS
ELV and RoHS Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free Status
Not Halogen-Free

China RoHS

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, click here

Please visit the Contact Us section for any non-product compliance questions.

Search Parts in this Series
71243Series

Mates With
JEDEC MO-206 modules

Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

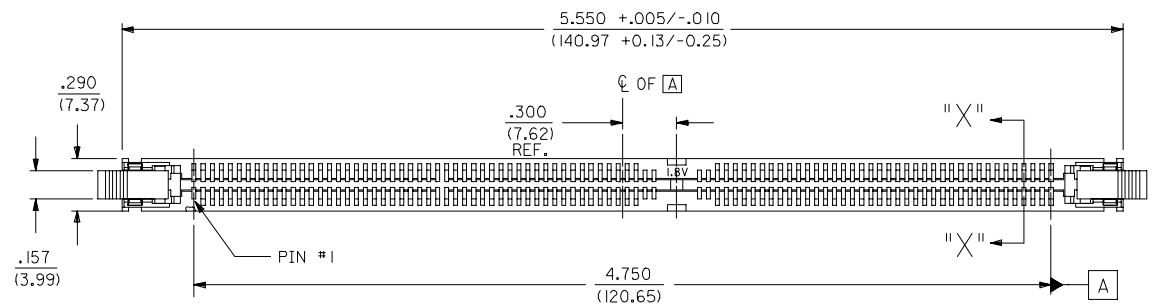
Material Info

Reference - Drawing Numbers

Product Specification	PS-71243-9999
Sales Drawing	SDA-71243-3***

This document was generated on 04/13/2010

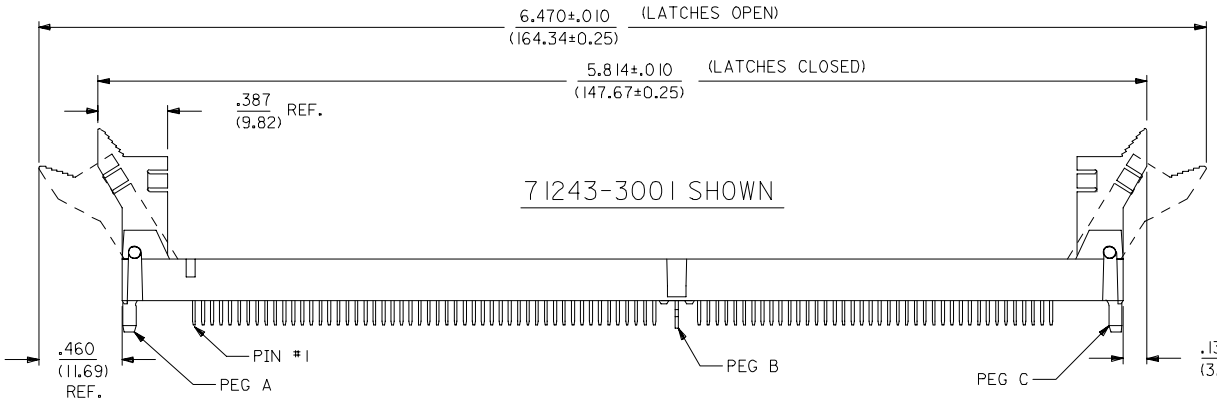
PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

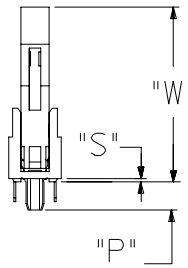


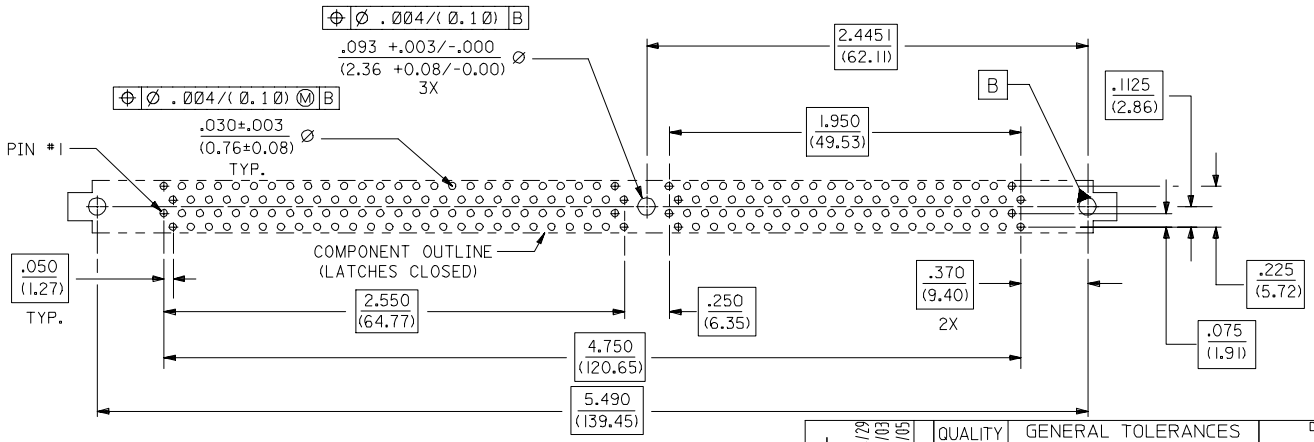
NOTES:
1. CARD SLOT ACCEPTS .050±.004 (1.27±0.10) MODULE THICKNESS. (MEASURED OVER P.C. PADS).
2. ALL PEGS ARE INTERFERENCE FITS TO PCB UNLESS NOTED .
3. REFER TO PRODUCT SPEC PS-71243-9999 FOR PERFORMANCE SPECIFICATIONS.
4. PRODUCT IS PACKAGED IN TRAYS PER PK-70873-0609.
5. RECOMMENDED MODULE LAYOUT SHALL BE PER SHEET 2.
6. RECOMMENDED PLATING ON MODULE PADS: 30 MICROINCH/(0.76 MICROMETER) MINIMUM HARD GOLD (Au) OVER 79 MICROINCH/(2.0 MICROMETER) MINIMUM NICKEL (Ni).
7. PRODUCT WILL HAVE DATE CODE STAMPED ON SIDE OF HOUSING.

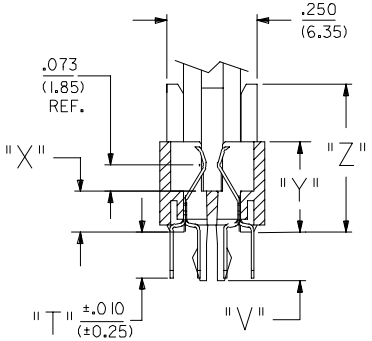
MATERIALS:
HOUSING - GLASS FILLED LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, COLOR: BLACK.
TERMINAL - PHOSPHOR BRONZE
LATCHES - GLASS FILLED HIGH TEMPERATURE NYLON, UL 94V-0, COLOR: IVORY.
PLATING:
SEE SHEET 2.

NOTE FOR LEAD FREE CONVERSION:
THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH LEAD.









SECTION "X-X"

SCALE 4:1

RECOMMENDED
P.C. BOARD HOLE PATTERN
(CONNECTOR SIDE)

SHT	REV
2	E
1	E

UPDATE REV LEVEL
EC NO: UCP2005-2368 2005/04/29
DRWN:BSMART 2005/05/03
CH'KD:BSMART 2005/05/05
APPR:SMILLER 2005/05/05
DESCRIPTION
REV

QUALITY SYMBOLS
▼=0
Ⓒ=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

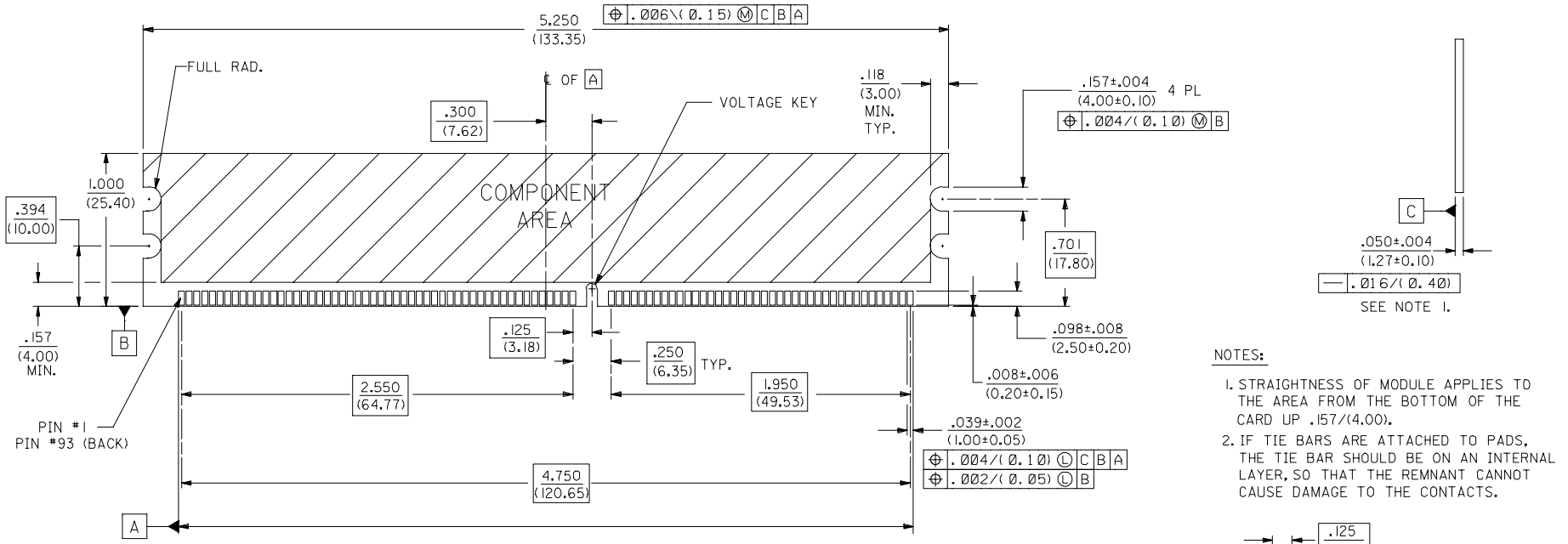
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± .005
2 PLACES	± 0.13	± .01
1 PLACE	± 0.25	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE	IN/MM
SCALE	2:1
DESIGN UNITS	INCH
	THIRD ANGLE PROJECTION
DRAWN BY / DATE	JCL 09/25/1997
CHECKED BY / DATE	JCL 09/25/1997
APPROVED BY / DATE	JCL 09/25/1997
TITLE	SALES ASSEMBLY .050/1.27 PITCH SINGLE KEY 184 CKT DDR DIMM
	MOLEX INCORPORATED
MATERIAL NO.	SEE TABLE
DOCUMENT NO.	SDA-71243-3***
SHEET NO.	1 OF 2
SIZE	C

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

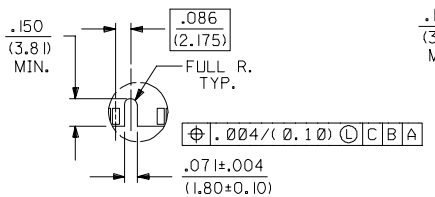
PART NUMBER	DESCRIPTION	VOLTAGE KEY	PEG A	PEG B	PEG C	DIM. "P"	DIM. "S"	DIM. "T"	DIM. "V"	DIM. "W"	DIM. "X"	DIM. "Y"	DIM. "Z"	LATCH COLOR	TERMINAL TYPE
71243-3001	1.8 VOLT VDDQ	CENTER	PLASTIC PEG	METAL FORKLOCK	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)	.135 (3.43)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	WHITE	NOT LUBRICATED
71243-3002	2.5 VOLT VDDQ	OFFSET LEFT	PLASTIC PEG	METAL FORKLOCK	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)	.135 (3.43)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	WHITE	NOT LUBRICATED
71243-3004	1.8 VOLT VDDQ	CENTER	PLASTIC PEG	METAL FORKLOCK	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)	.135 (3.43)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	WHITE	LUBRICATED
71243-3005	2.5 VOLT VDDQ	OFFSET LEFT	PLASTIC PEG	METAL FORKLOCK	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)	.135 (3.43)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	WHITE	LUBRICATED
71243-3007	2.5 VOLT VDDQ	OFFSET LEFT	PLASTIC PEG	NONE	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)		.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	WHITE	NOT LUBRICATED
71243-3009	1.8 VOLT VDDQ	CENTER	PLASTIC PEG	METAL FORKLOCK	PLASTIC PEG	.155 (3.94)	.020 (0.51)	.127 (3.23)	.135 (3.43)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	BLACK	NOT LUBRICATED



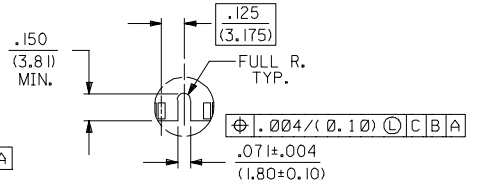
RECOMMENDED MODULE LAYOUT
184 CKT 3.3V SHOWN

NOTES:

1. STRAIGHTNESS OF MODULE APPLIES TO THE AREA FROM THE BOTTOM OF THE CARD UP .157/(4.00).
2. IF TIE BARS ARE ATTACHED TO PADS, THE TIE BAR SHOULD BE ON AN INTERNAL LAYER, SO THAT THE REMNANT CANNOT CAUSE DAMAGE TO THE CONTACTS.



OFFSET LEFT KEY



CENTERED KEY

PLATING:

CONTACT AREA NOT LUBRICATED:
GOLD (Au) FLASH: THICKNESS=2-10 MICROINCH/(0.05-0.25 MICRO METER), OVER PALLADIUM-NICKEL (Pd-Ni): THICKNESS=30 MICROINCH/(0.76 MICROMETER) MINIMUM.

CONTACT AREA LUBRICATED:
MOLEX EBI LUBRICANT APPLIED OVER GOLD (Au) FLASH: THICKNESS=2-10 MICROINCH/(0.05-0.25 MICRO METER), OVER PALLADIUM-NICKEL (Pd-Ni): THICKNESS=30 MICROINCH/(0.76 MICROMETER) MINIMUM.

SOLDER TAILS:
TIN (Sn): THICKNESS=150 MICROINCH/(3.81 MICROMETER) MINIMUM.

UNDERPLATE:
NICKEL (Ni) OVER ENTIRE TERMINAL.

ADD 71243-3009
EC NO: UCP2005-2368 2005/04/29
DRWN:BSMART 2005/05/03
CHKD:BSMART
APPR:SMILLER 2005/05/05
DESCRIPTION
REV

QUALITY SYMBOLS
▼=0
Ⓒ=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± .005
2 PLACES	± 0.13	± .01
1 PLACE	± 0.25	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: IN/MM
SCALE: 2:1
DESIGN UNITS: INCH
THIRD ANGLE PROJECTION

DRAWN BY: JCL DATE: 09/25/1997
CHECKED BY: JCL DATE: 09/25/1997
APPROVED BY: JCL DATE: 09/25/1997

TITLE: SALES ASSEMBLY 0505/1.27 PITCH SINGLE KEY 184 CKT DDR DIMM

MOLEX INCORPORATED

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SDA-71243-3***
SHEET NO.: 2 OF 2

SIZE C

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